



DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	RDS(on) Max	I _D T _A = +25°C
-50V	8Ω @ V _{GS} = -5V	-220mA

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General purpose interfacing switches
- Power management functions
- Analog switches

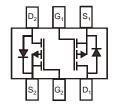


Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
 - For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: SOT563
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
 Solderable Per MIL-STD-202, Method 208 (3)
- Weight: 0.003 grams (Approximate)



TOP VIEW Internal Schematic

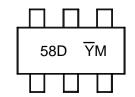
Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Number	Package	Qty.	Carrier	
DMP58D1LV-7	SOT563	3,000	Reel	
DMP58D1LV-13	SOT563	10,000	Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



58D = Product Type Marking Code YM = Date Code Marking Y = Year (ex: J = 2022) M = Month (ex: 9 = September)

Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	М	N	0	Р	R	S	Т	U	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V _{DSS}	-50	V	
Gate-Source Voltage	Vgss	±20	V		
Continuous Drain Current (Note 6) V _{GS} = -5V	lo	-220 -180	mA		
Maximum Body Diode Forward Current (Note 6)		Is	-220	mA	
Pulsed Drain Current (Note 6)	I _{DM}	-1	Α		
Pulsed Source Current (Note 6)			Isм	-1	Α

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

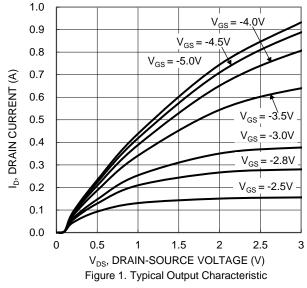
Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		P _D	0.49	W
Thermal Resistance, Junction to Ambient (Note 5)	RеJA	259	°C/W	
Total Power Dissipation (Note 6)		PD	0.78	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	159	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	-50	_	_	V	Vgs = 0V, ID = -250µA	
Zara Cata Valtara Duain Comunit		_	_	1.0	μΑ	V _{DS} = -50V, V _{GS} = 0V	
Zero Gate Voltage Drain Current	IDSS	_	_	500	nA	V _{DS} = -25V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 7)	•		•	•	•		
Gate Threshold Voltage	VGS(TH)	-0.8	_	-2.0	V	V _{DS} = V _{GS} , I _D = -250uA	
Static Drain-Source On-Resistance	RDS(ON)	_	2.2	8	Ω	V _G S = -5V, I _D = -100mA	
Diode Forward Voltage	VsD	_	-0.8	-1.4	V	Vgs = 0V, Is = -100mA	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	37	_	pF		
Output Capacitance	Coss		5.8	_	pF	V _{DS} = -25V, V _{GS} = 0V, -f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	3.5		pF	1 - 1.000112	
Gate Resistance	Rg		240	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -5V)	Qg	_	0.6	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	1.2	_	nC	\/ 40\/ I= 400m A	
Gate-Source Charge	Qgs	_	0.3	_	nC	$V_{DS} = -10V, I_{D} = -100mA$	
Gate-Drain Charge	Q _{gd}	_	0.01	_	nC	1	
Turn-On Delay Time	t _{D(on)}	_	2.6	_	ns		
Turn-On Rise Time	tr	_	12	_	ns	V _{DD} = -30V, V _{GS} = -10V,	
Turn-Off Delay Time	t _{D(off)}	_	36.6	_	ns	$R_G = 50\Omega$, $I_D = -270mA$	
Turn-Off Fall Time	tf	_	21	_	ns]	
Body Diode Reverse Recovery Time	t _{RR}	_	67	_	ns	I _F = -1A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	78	_	nC	I _F = -1A, di/dt = 100A/μs	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:





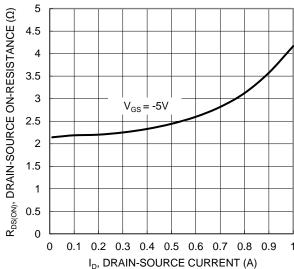


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

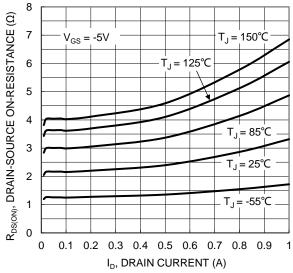


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

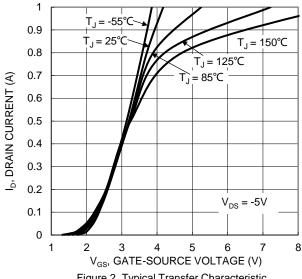


Figure 2. Typical Transfer Characteristic

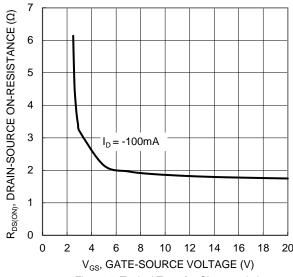


Figure 4. Typical Transfer Characteristic

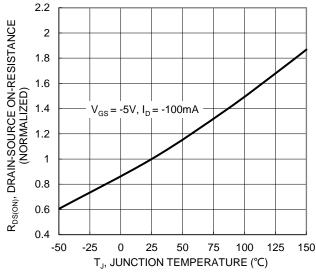


Figure 6. On-Resistance Variation with Temperature



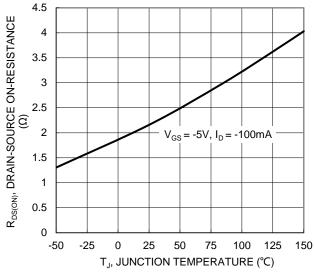


Figure 7. On-Resistance Variation with Temperature

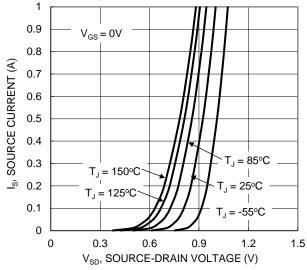


Figure 9. Diode Forward Voltage vs. Current

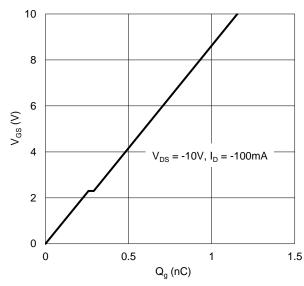


Figure 11. Gate Charge

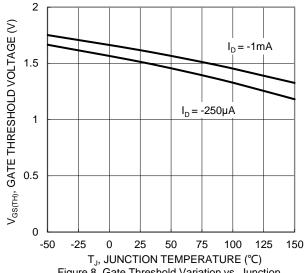


Figure 8. Gate Threshold Variation vs. Junction
Temperature

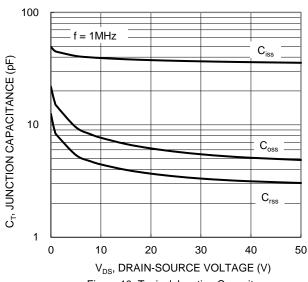


Figure 10. Typical Junction Capacitance

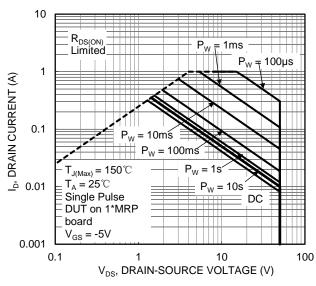


Figure 12. SOA, Safe Operation Area



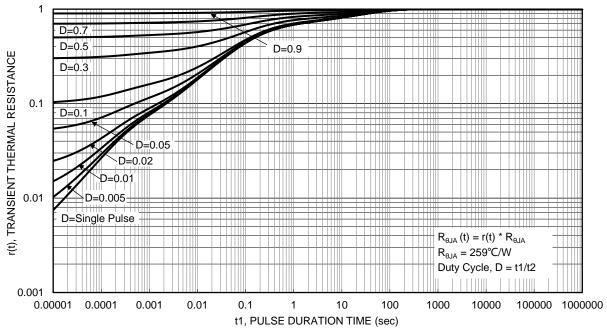


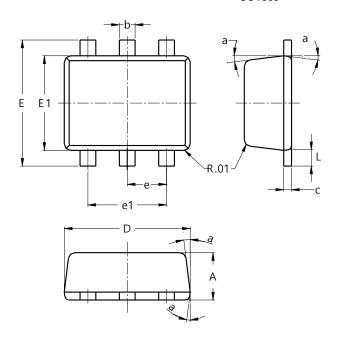
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563

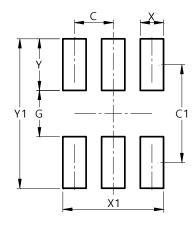


SOT563						
Dim	Min	Max	Тур			
Α	0.55	0.60				
b	0.15	0.30	0.20			
С	0.10	0.18	0.11			
D	1.50	1.70	1.60			
Е	1.55	1.70	1.60			
E1	1.10	1.25	1.20			
е			0.50			
e1	0.90	1.10	1.00			
L	0.10	0.30	0.20			
а	8°	9°	7°			
All	All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT563



Dimensions	Value (in mm)
С	0.500
C1	1.270
G	0.600
Х	0.300
X1	1.300
Y	0.670
Y1	1.940



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